onsemi

Silicon Carbide (SiC) MOSFET – 22 mohm, 1200 V, M3S, TO-247-4

NTH4L022N120M3S

Features

- Typ. $R_{DS(on)} = 22 \text{ m}\Omega @ V_{GS} = 18 \text{ V}$
- Low Switching Losses (Typ. EON 490 µJ at 40 A, 800 V)
- 100% Avalanche Tested
- This Device is Halide Free and RoHS Compliant with exemption 7a, Pb–Free 2LI (on second level interconnection)

Typical Applications

- Solar Inverters
- Electric Vehicle Charging Stations
- UPS (Uninterruptible Power Supplies)
- Energy Storage Systems
- SMPS (Switch Mode Power Supplies)

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Param	Symbol	Value	Unit		
Drain-to-Source Voltage			V _{DSS}	1200	V
Gate-to-Source Voltage			V _{GS}	-10/+22	V
Recommended Operation Values T _C < 175°C of Gate-to-Source Voltage		V _{GSop}	-3/+18	V	
Continuous Drain Current (Note 1)	Steady State	$T_C = 25^{\circ}C$	I _D	68	A
Power Dissipation (Note 1)			P _D	352	W
Continuous Drain Current (Note 1)	Steady T _C = 100°C State		I _D	48	A
Power Dissipation (Note 1)			PD	176	W
Pulsed Drain Current (Note 2)	Т _С	= 25°C	I _{DM}	246	A
Operating Junction and Storage Temperature Range			T _J , T _{stg}	–55 to +175	°C
Source Current (Body Diode) $T_{C} = 25^{\circ}C$, $V_{GS} = -3 V$			۱ _S	72	A
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 23.1 A, L = 1 mH) (Note 3)			E _{AS}	267	mJ
Maximum Lead Temperature for Soldering (1/8" from case for 5 s)			ΤL	300	°C

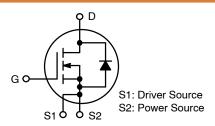
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Repetitive rating, limited by max junction temperature.

3. EAS of 267 mJ is based on starting T_J = 25°C; L = 1 mH, I_{AS} = 23.1 A, V_{DD} = 100 V, V_{GS} = 18 V.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
1200 V	30 mΩ @ 18 V	68 A



N-CHANNEL MOSFET



MARKING DIAGRAM



H4L022120M3S = Specific Device Code

A = Assembly Location

Y = Year

WW = Work Week

ZZ = Lot Traceability

ORDERING INFORMATION

Device	Package	Shipping	
NTH4L022N120M3S	TO247-4L	30 Units / Tube	

Table 1. THERMAL CHARACTERISTICS

Parameter	Symbol	Тур	Мах	Unit
Junction-to-Case - Steady State (Note 1)		0.33	0.43	°C/W
Junction-to-Ambient - Steady State (Note 1)			40	

Table 2. ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

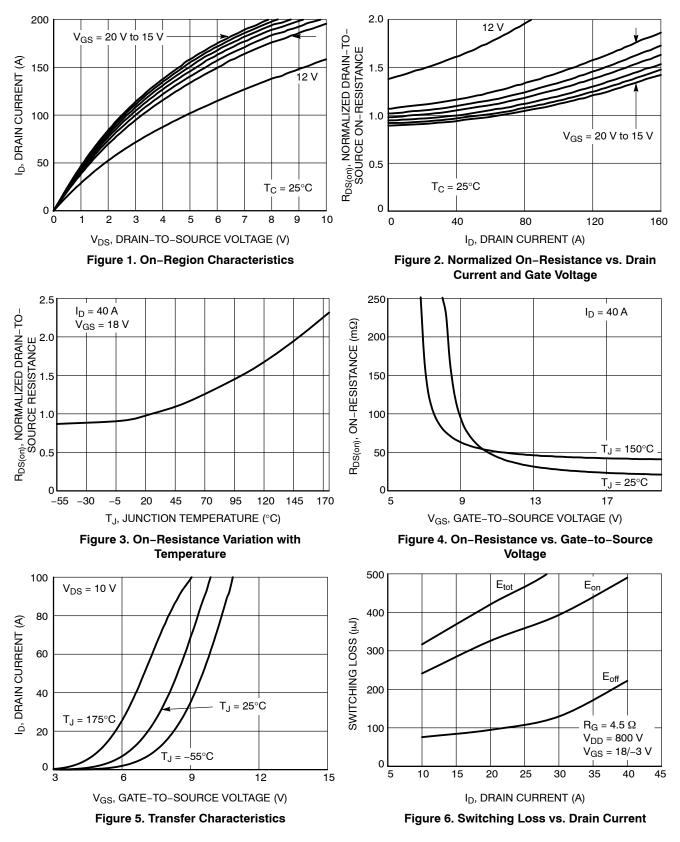
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
OFF-STATE CHARACTERISTICS	-	•	-	-	-	-
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = 1 mA	1200	-	-	V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J	$I_D = 1$ mA, referenced to 25°C	-	0.3	-	V/°C
Zero Gate Voltage Drain Current	I _{DSS}	$ \begin{array}{l} V_{GS} = 0 \ V, \\ V_{DS} = 1200 \ V \end{array} \hspace{1.5cm} T_J = 25^{\circ}C \\ \end{array} $	-	-	100	μA
Gate-to-Source Leakage Current	I _{GSS}	$V_{GS} = +22/-10 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$	-	-	±1	μA
ON-STATE CHARACTERISTICS (Note 2)		•				
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 20 \text{ mA}$	2.04	2.72	4.4	V
Recommended Gate Voltage	V _{GOP}		-3	-	+18	V
Drain-to-Source On Resistance	R _{DS(on)}	V_{GS} = 18 V, I_D = 40 A, T_J = 25°C	-	22	30	mΩ
		V_{GS} = 18 V, I _D = 40 A, T _J = 175°C	-	47	-	
Forward Transconductance	9 FS	V _{DS} = 10 V, I _D = 40 A	-	34	-	S
CHARGES, CAPACITANCES & GATE RES	ISTANCE	·				
Input Capacitance	C _{ISS}	V_{GS} = 0 V, f = 1 MHz, V_{DS} = 800 V	-	3175	-	pF
Output Capacitance	C _{OSS}		-	146	-	
Reverse Transfer Capacitance	C _{RSS}		-	12	-	
Total Gate Charge	Q _{G(TOT)}	$V_{GS} = -3/18 \text{ V}, V_{DS} = 800 \text{ V},$	-	151	-	nC
Threshold Gate Charge	Q _{G(TH)}	I _D = 40 A	-	20	-	
Gate-to-Source Charge	Q _{GS}		-	34	-	
Gate-to-Drain Charge	Q _{GD}		-	40	-	
Gate-Resistance	R _G	f = 1 MHz	-	1.5	-	Ω
SWITCHING CHARACTERISTICS		·				
Turn–On Delay Time	t _{d(ON)}	$V_{GS} = -3/18 \text{ V}, V_{DS} = 800 \text{ V},$	-	18	_	ns
Rise Time	t _r	$I_D = 40 \text{ A}, R_G = 4.5 \Omega$ Inductive load (Note 4)	-	24	-	-
Turn-Off Delay Time	t _{d(OFF)}		-	48	_	
Fall Time	t _f		-	13	-	
Turn–On Switching Loss	E _{ON}		-	490	-	μJ
Turn-Off Switching Loss	E _{OFF}	1	-	221	-	
Total Switching Loss	E _{tot}	1	_	771	-	
SOURCE-DRAIN DIODE CHARACTERIST		•				
Continuous Source-Drain Diode Forward Current	I _{SD}	V_{GS} = -3 V, T_C = 25°C	-	-	72	А
Pulsed Source-Drain Diode Forward Current (Note 2)	I _{SDM}	1	-	-	246	
Forward Diode Voltage	V _{SD}	V _{GS} = -3 V, I _{SD} = 40 A, T _J = 25°C	_	4.5	_	V

Table 2. ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified) (continued)

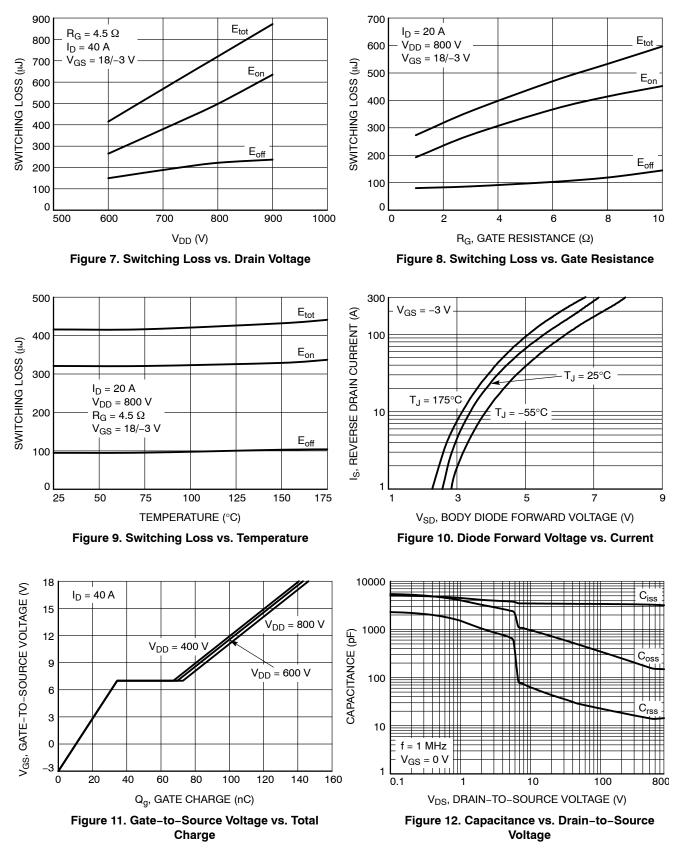
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit		
SOURCE-DRAIN DIODE CHARACTERISTICS								
Reverse Recovery Time	t _{RR}	V _{GS} = -3/18 V, I _{SD} = 40 A, dI _S /dt = 1000 A/μs, V _{DS} = 800 V	-	22	-	ns		
Reverse Recovery Charge	Q _{RR}	$d_{S}/dl = 1000 A/\mu s, v_{DS} = 800 v$	-	138	-	nC		
Reverse Recovery Energy	E _{REC}		-	5	-	μJ		
Peak Reverse Recovery Current	I _{RRM}		-	13	-	А		
Charge Time	T _A]	-	13	-	ns		
Discharge Time	Τ _Β]	_	9	-	ns		

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. E_{ON}/E_{OFF} result is with body diode

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (continued)



TYPICAL CHARACTERISTICS (continued)

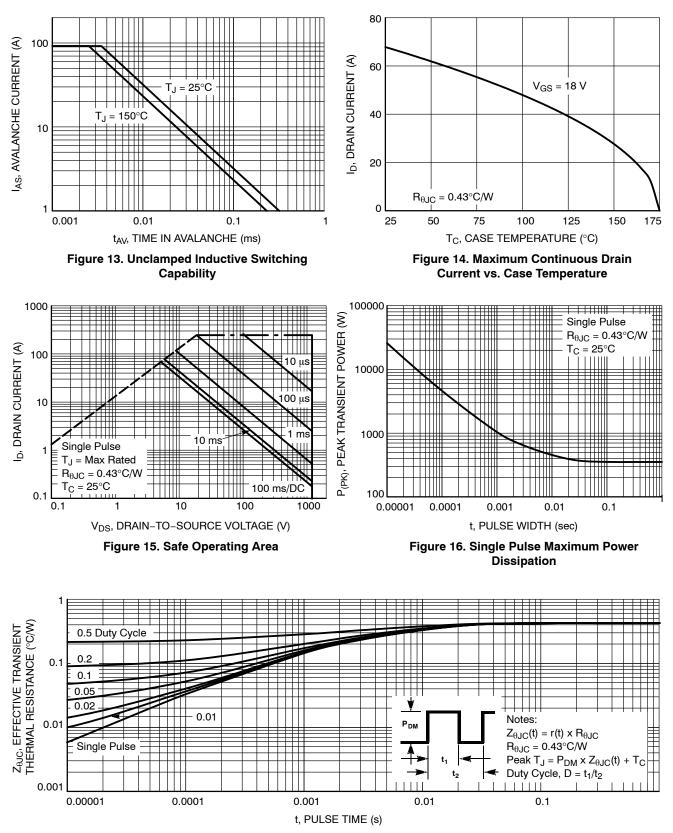
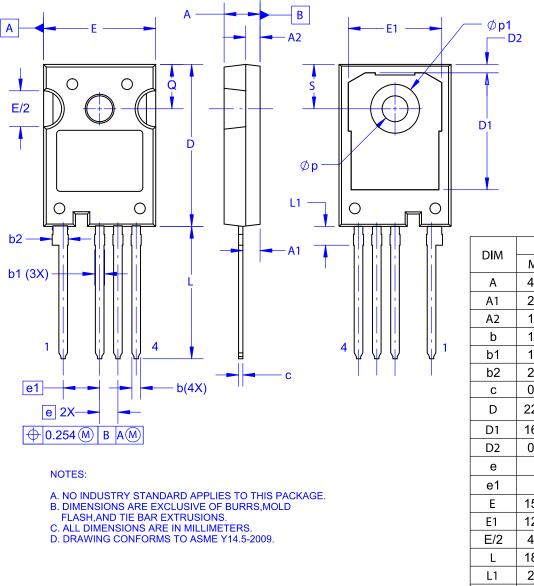


Figure 17. Junction-to-Case Transient Thermal Response



TO-247-4LD CASE 340CJ ISSUE A

DATE 16 SEP 2019



	MIL	MILLIMETERS				
DIM	MIN	NOM	MAX			
А	4.80	5.00	5.20			
A1	2.10	2.40	2.70			
A2	1.80	2.00	2.20			
b	1.07	1.20	1.33			
b1	1.20	1.40	1.60			
b2	2.02	2.22	2.42			
С	0.50	0.60	0.70			
D	22.34	22.54	22.74			
D1	16.00	16.25	16.50			
D2	0.97	1.17	1.37			
е	2	2.54 BSC				
e1	Ę	5.08 BSC	2			
Е	15.40	15.60	15.80			
E1	12.80	13.00	13.20			
E/2	4.80	5.00	5.20			
L	18.22	18.42	18.62			
L1	2.42	2.62	2.82			
р	3.40	3.60	3.80			
p1	6.60	6.80	7.00			
Q	5.97	6.17	6.37			
S	5.97	6.17	6.37			

DOCUMENT NUMBER:	98AON13852G	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.			
DESCRIPTION:	TO-247-4LD		PAGE 1 OF 1		
ON Semiconductor and 🕕 are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries.					

ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and calcular performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

TECHNICAL SUPPORT

onsemi Website: www.onsemi.com

Email Requests to: orderlit@onsemi.com

North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support: Phone: 00421 33 790 2910 For additional information, please contact your local Sales Representative